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# 1 Electrical ratings

Symbol	Parameter	Value	Unit		
Vсво	Collector-base voltage ( $I_E = 0$ )	-100	V		
VCEO	Collector-emitter voltage ( $I_B = 0$ )	-100	V		
Vebo	Emitter-base voltage ( $I_{\rm C} = 0$ )	-5	V		
۱ <sub>C</sub>	Collector current	-3	A		
I <sub>CM</sub>	Collector peak current	-5	A		
I <sub>B</sub>	Base current	-1	A		
P <sub>TOT</sub>	Total dissipation at $T_c = 25 \text{ °C}$	15	W		
T <sub>stg</sub>	Storage temperature range		°C		
Тj	Operating junction temperature range	-65 to 150 °C			

#### Table 2. Absolute maximum ratings

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	8.3	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	50	°C/W

1. When mounted on a 1-inch<sup>2</sup> FR-4 board, 2oz Cu



## 2 Electrical characteristics

 $T_{case}$ =25 °C unless otherwise specified.

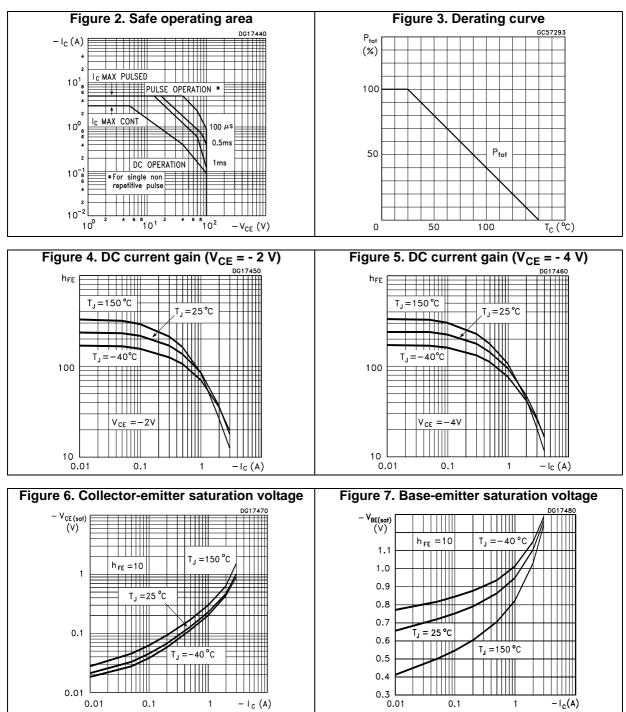
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = - 100 V		-	-20	μΑ
I <sub>CEO</sub>	Collector cut-off current $(I_B = 0)$	V <sub>CB</sub> = - 60 V		-	-50	μΑ
I <sub>EBO</sub>	Emitter cut-off current (I <sub>C</sub> = 0)	V <sub>EB</sub> = - 5 V		-	-0.1	mA
V <sub>CEO(sus)</sub>	Collector-emitter sustaining voltage $(I_B = 0)$	I <sub>C</sub> = - 30 mA	-100	-		V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	I <sub>C</sub> = - 3 A, I <sub>B</sub> = - 375 mA		-	-1.2	V
V <sub>BE(on)</sub>	Base-emitter on voltage	$I_{C} = -3 \text{ A}, V_{CE} = -4 \text{ V}$		-	-1.8	V
h <sub>FE</sub>	DC ourrent gain	$I_{C} = -1 \text{ A}, V_{CE} = -4 \text{ V}$	25	-		
''FE	DC current gain	$I_{C} = -3 \text{ A}, V_{CE} = -4 \text{ V}$	10	-	50	

Table 4. C	n/off states
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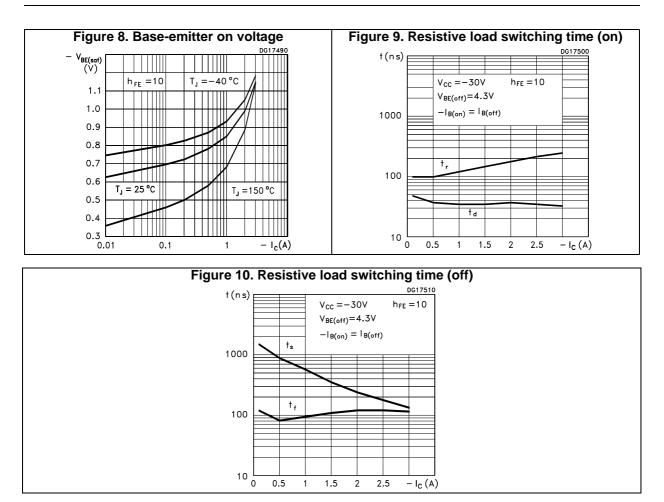
1. Pulse test: pulse duration  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ 



### 2.1 Electrical characteristics (curves)

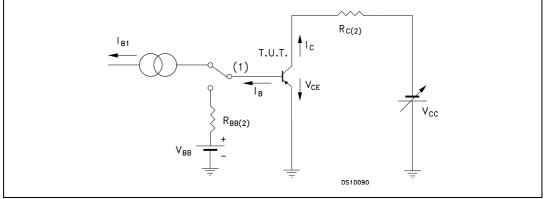


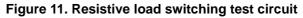






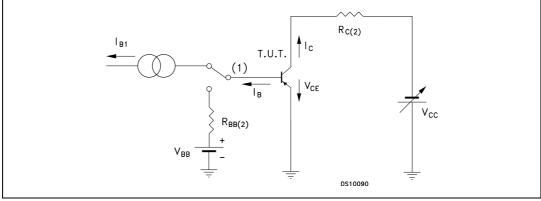
## 3 Test circuits





- 1. Fast electronic switch
- 2. Non-inductive resistor





1. Fast electronic switch

2. Non-inductive resistor

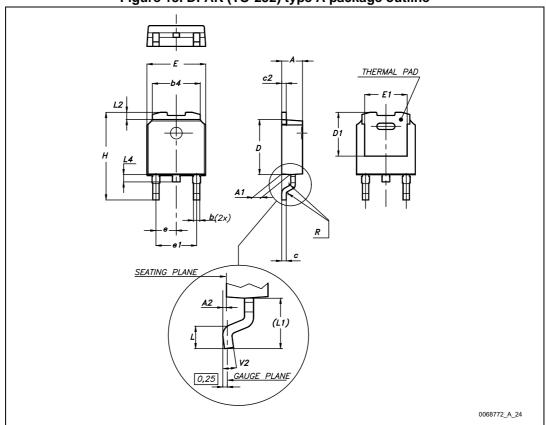
3. Fast recovery rectifier



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 4.1 DPAK (TO-252) type A package information



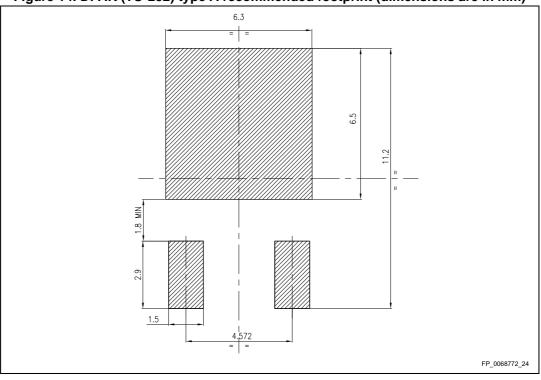
### Figure 13. DPAK (TO-252) type A package outline



Dim		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	4.60	4.70	4.80
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
(L1)	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

Table 5. DPAK (TO-252) type A mechanical data



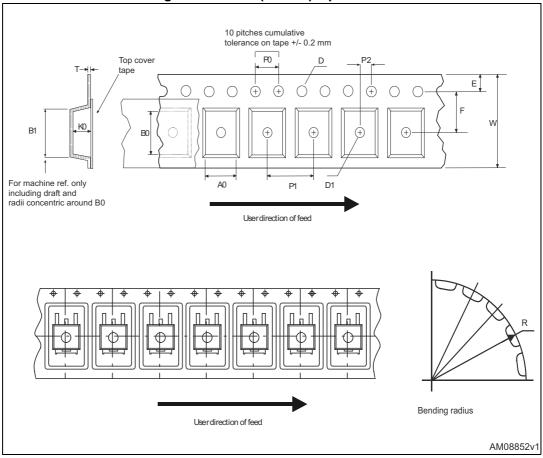


### Figure 14. DPAK (TO-252) type A recommended footprint (dimensions are in mm)

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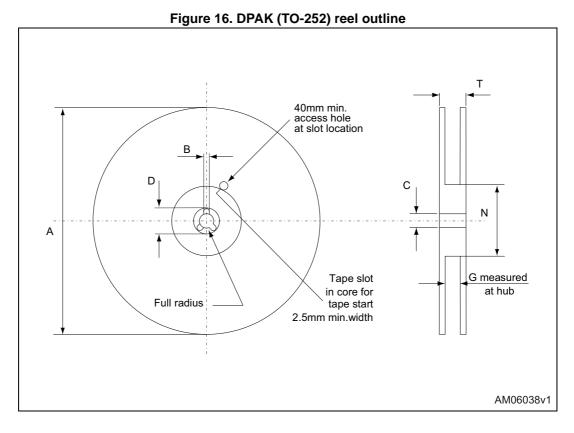


## 4.2 DPAK (TO-252) packing information



### Figure 15. DPAK (TO-252) tape outline





### Table 6. DPAK (TO-252) tape and reel mechanical data

	Таре			Reel		
Dim.	mm		Dim	mm		
	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	А		330	
B0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
E	1.65	1.85	Ν	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1		Base qty.	2500	
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				



## 5 Revision history

Date	Revision	Changes		
01-Jun-2007	1	First release		
09-Nov-2009	2	Updated package mechanical data.		
14-Jan-2010	3	Modified Table 3 on page 2.		
19-Jun-2012	4	Modified: mechanical data updated		
24-Jan-2018	5	Modified title. Modified features on cover page. Updated <i>Section 4: Package information</i> . Minor text changes.		



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